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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/758,146	01/14/2004	Mark Alan Thompson	NPT-65.0399	4640
7590 11/02/2005 WAGNER, MURABITO & HAO LLP			EXAMINER	
			AHMED, SHAMIM	
Two North Mar San Jose, CA	ket Street, Third Floor		ART UNIT	PAPER NUMBER
Jan Jose, Ort 75115			1765	

DATE MAILED: 11/02/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
	10/758,146	THOMPSON ET AL.				
Office Action Summary	Examiner	Art Unit				
	Shamim Ahmed	1765				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status						
1) Responsive to communication(s) filed on 14 Ja	1)⊠ Responsive to communication(s) filed on <u>14 January 2004</u> .					
2a) ☐ ,This action is FINAL . 2b) ☑ This	action is non-final.					
3) Since this application is in condition for allowar	secution as to the merits is					
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	3 O.G. 213.				
Disposition of Claims						
4) ☐ Claim(s) 1-21 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-21 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	vn from consideration.					
Application Papers						
9) The specification is objected to by the Examiner 10) The drawing(s) filed on 14 January 2004 is/are: Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Examiner	a)⊠ accepted or b)⊡ objected drawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s) Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa					

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 2. Claims 1-21 are rejected under 35 U.S.C. 102(e) as being anticipated by Roy et al (6,958,248).

The applied reference has a common inventor with the instant application.

Based upon the earlier effective U.S. filing date of the reference, it constitutes prior art under 35 U.S.C. 102(e). This rejection under 35 U.S.C. 102(e) might be overcome either by a showing under 37 CFR 1.132 that any invention disclosed but not claimed in the reference was derived from the inventor of this application and is thus not the invention "by another," or by an appropriate showing under 37 CFR 1.131.

Roy et al disclose a milling process of forming fine opening or trench through a wafer substrate using ion beam, which resemble as the claimed charged particle beam and detecting the endpoint of the milling process by acquiring optical images of the trench and registering the acquired image with reference image with the help of computer aided design (CAD) layout image (col.2, lines 49-67).

Application/Control Number: 10/758,146

Art Unit: 1765

Roy et al disclose that the process enables the ion beam imaging to map or navigate the wafer from the back side to locate positions of various material and diffusion regions (col.3, lines 52-59).

Roy et al disclose that the wafer is thinned prior to the forming the trench or opening and the process further comprises forming a coarse opening/trench and ion milling the trench to form fine trench using first focused ion beam (FIB) current and a second FIB current, wherein the second current is less than the first current and stopping the milling process upon detection of the desired voltage contrast (see col.5, lines 45-65, col.6, lines 39-53, col.8, lines 51-63 and figure 2).

3. Claims 1-3 are rejected under 35 U.S.C. 102(e) as being anticipated by Talbot et al (6,518,571).

Talbot et al disclose a milling process for forming opening through a substrate using focused ion beam (FIB) and guiding the milling process by acquiring optical images from the back side of the substrate, which resemble with the claimed end pointing of the milling process (see the abstract).

Talbot et al also disclose that the alignment of the acquired optical images to a CAD layout data is used to precisely navigate the milling process (col.7, lines 26-62).

Conclusion

4. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Roy et al (6,855,622) teach ion milling process using FIB for etching a substrate and the process is navigated from the backside of the substrate using optical imaging technique.

Art Unit: 1765

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Shamim Ahmed whose telephone number is (571) 272-1457. The examiner can normally be reached on M-Thu (7:00-5:30) Every Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine G. Norton can be reached on (571) 272-1465. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Shamim Ahmed Primary Examiner Art Unit 1765

SA October 31, 2005